



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE **COPY OF PAPERS
ORIGINALLY FILED**

Applicant : Se-Lee Chang et al. Art Unit : 1711
Serial No. : 09/690,271 Examiner : Susan W. Berman
Filed : October 17, 2000
Title : RESIN COMPOSITION FOR MANUFACTURING OPTICAL FIBER RIBBON
AND METHOD FOR PREPARING RESIN FOR MANUFACTURING OPTICAL
FIBER RIBBON USING THE SAME

Commissioner for Patents
Washington, D.C. 20231

#4
7/27/02
NW

TRANSMITTAL OF DECLARATION UNDER 37 C.F.R. § 1.131

Applicants filed on June 24, 2002 a response to the office action dated February 22, 2002, along with an unsigned declaration of co-inventor Se-Lee Chang under 37 C.F.R. § 1.131. Attached hereto is a facsimile copy of the same declaration signed by Se-Lee Chang on June 24, 2002.

Please apply any charges for extension or other fees to our Deposit Account No. 06-1050.

Respectfully submitted,

Date: 6-26-02

Y. Rocky Tsao
Y. Rocky Tsao, Ph.D., J.D.
Attorney for Applicants
Reg. No. 34,053

Fish & Richardson P.C.
225 Franklin Street
Boston, Massachusetts 02110-2804
Telephone: (617) 542-5070
Facsimile: (617) 542-8906

20460995.doc

RECEIVED
JUL 23 2002
TC 1700

CERTIFICATE OF MAILING BY FIRST CLASS MAIL

I hereby certify under 37 CFR §1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated below and is addressed to the Commissioner for Patents, Washington, D.C. 20231.

June 27, 2002
Date of Deposit
Joanne D Boyle
Signature
Joanne D. Boyle
Typed or Printed Name of Person Signing Certificate



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Se-Lee Chang et al.

Art Unit : 1711

COPY OF PAPERS
ORIGINALLY FILED

Serial No. : 09/690,271

Examiner : Susan W. Berman

Filed : October 17, 2000

Title : RESIN COMPOSITION FOR MANUFACTURING OPTICAL FIBER RIBBON
AND METHOD FOR PREPARING RESIN FOR MANUFACTURING OPTICAL
FIBER RIBBON USING THE SAMECommissioner for Patents
Washington, D.C. 20231DECLARATION UNDER 37 C.F.R. § 1.131

I, Se-Lee Chang, hereby declare that:

1. I am a co-inventor of the subject matter described and claimed in the above-identified patent application.

2. I understand that U.S. Patent No. 5,986,018 to Yamaguchi et al. and U.S. Patent No. 6,023,547 to Tortorello have been cited as prior art to reject claims 1-3, 6-9, and 11-19 of this application. The '018 patent and the '547 patent issued from applications filed on February 20, 1998 and June 9, 1997, respectively.

3. Prior to June 9, 1997, I and co-inventors Jung-Hyun Oh, Woo-Jeong Oh and Ki-Sung Jung had worked together to complete the conception of the invention as described and claimed in the application in Republic of Korea, and had diligently worked also in the same country toward its actual reduction to practice, as evidenced by a copy of three pages of an experimental report, as well as its English translation, attached hereto. Shown in these three pages are a protocol and results of experiments designed to prepare and test an ERIFON silicone type ribbon resin, which is within the scope of the rejected claims. Two dates have been blocked off, both of which are prior to June 9, 1997.

CERTIFICATE OF MAILING BY FIRST CLASS MAIL

I hereby certify under 37 CFR §1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated below and is addressed to the Commissioner for Patents, Washington, D.C. 20231.

Date of Deposit

June 27 2002

Signature

Joanne D. Boyle

Typed or Printed Name of Person Signing Certificate

RECEIVED
JUL 23 2002
IC 1700

Applicant : Se-Lee Chang et al.
Serial No. : 09/690,271
Filed : October 17, 2000
Pag : 2

Attorney's D ck t No.: 12495-002001 / OPP 000621
US

4. All statements made herein of my knowledge are true and that all statements made on information and belief are believed to be true; and further these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Respectfully submitted,

Date: June 24, 2002.



Se-Lee Chang

20457572.doc